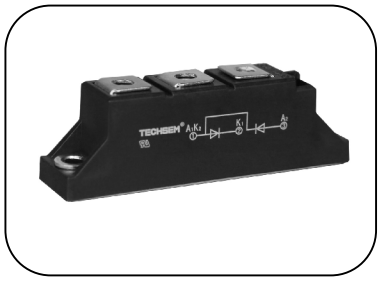


Features：

- Isolated mounting base 2500V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

Typical Applications

- Various rectifiers
- DC supply for PWM inverter

V_{RRM}	Type & Outline
2000V	MDx55-20-215F3
2200V	MDx55-22-215F3
2500V	MDx55-25-215F3
2500V	MD55-25-215F3G

MDx stands for any type of **MDC, MDA, MDK**

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j(°C)	VALUE			UNIT
				Min	Type	Max	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, T_C=100°C	150			55	A
$I_{F(RMS)}$	RMS forward current					86	A
I_{RRM}	Repetitive peak current	at V_{RRM}	150			8	mA
I_{FSM}	Surge forward current	V_R=60%V_{RRM},t=10ms half sine,	150			1.30	kA
I^2t	I^2t for fusing coordination					8.45	10^3A^2s
V_{FO}	Threshold voltage		150			0.85	V
r_F	Forward slope resistance					3.76	mΩ
V_{FM}	Peak forward voltage	I_{FM}=170A	25			1.55	V
$R_{th(j-c)}$	Thermal resistance Junction to case	Single side cooled per chip				0.68	°C/W
$R_{th(c-h)}$	Thermal resistance case to heatsink	Single side cooled per chip				0.20	°C/W
V_{iso}	Isolation voltage	50Hz,R.M.S,t=1min,I_{iso}:1mA(MAX)		2500			V
F_m	Terminal connection torque(M5)			2.5		4.0	N·m
	Mounting torque(M6)			4.5		6.0	N·m
T_{vj}	Junction temperature			-40		150	°C
T_{stg}	Stored temperature			-40		125	°C
W_t	Weight				120		g
Outline	215F3						

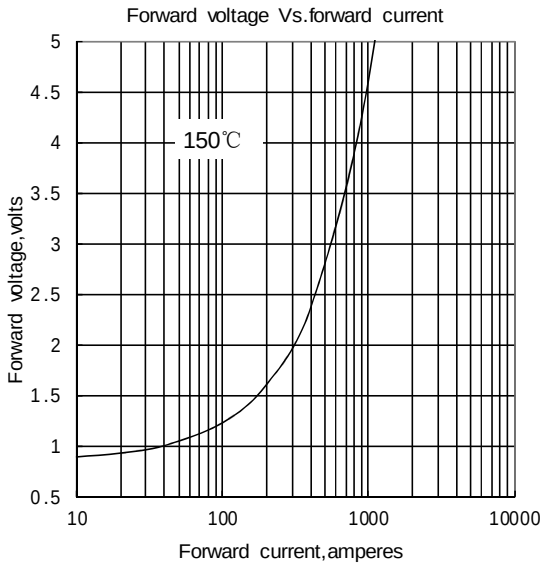


Fig.1

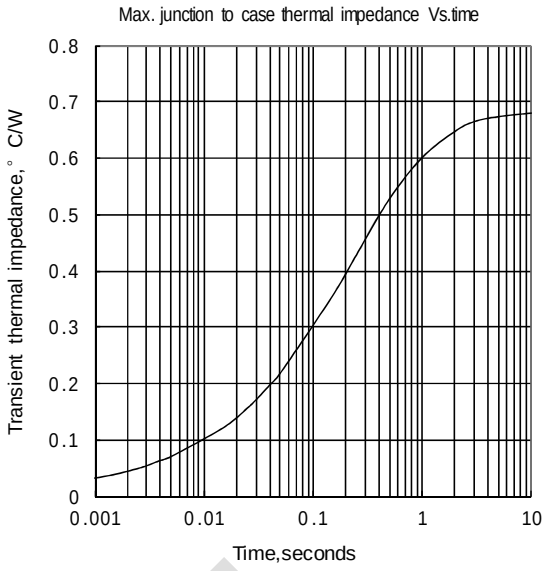


Fig.2

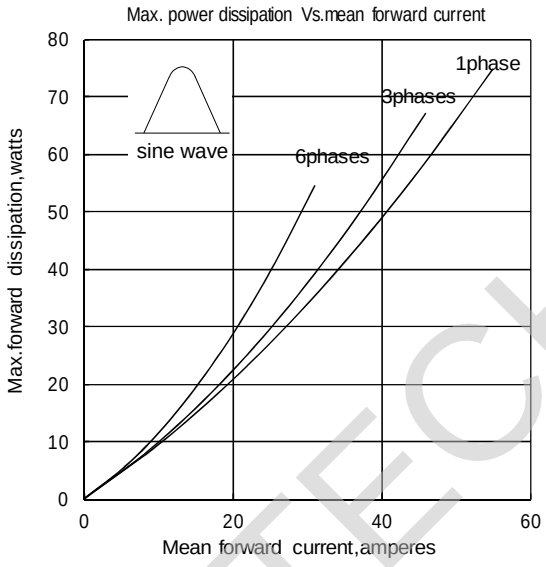


Fig.3

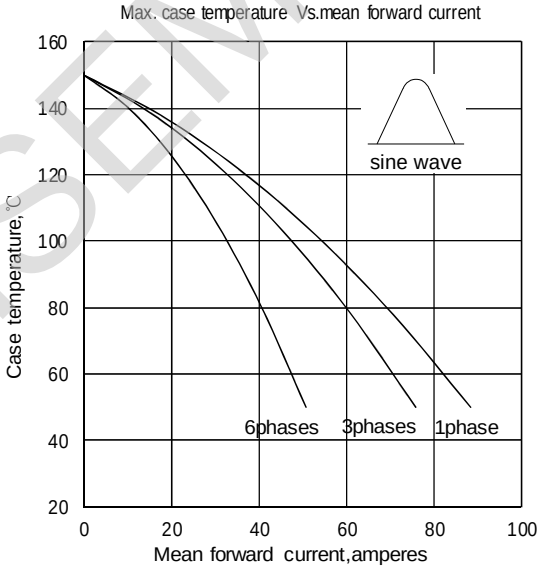


Fig.4

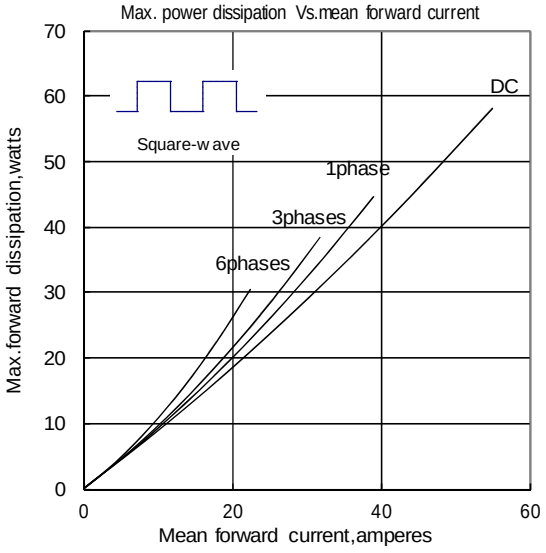


Fig.5

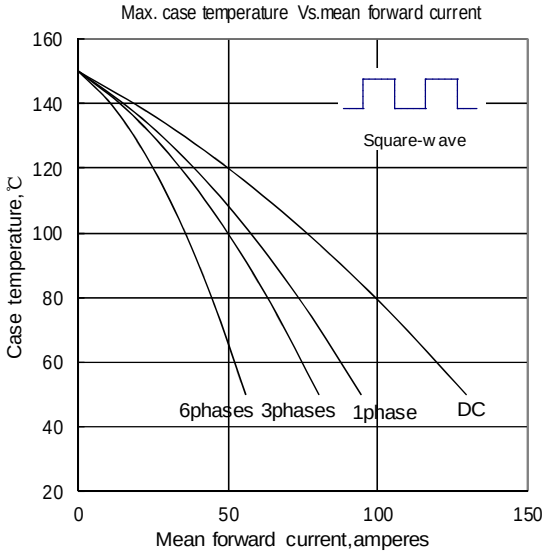


Fig.6

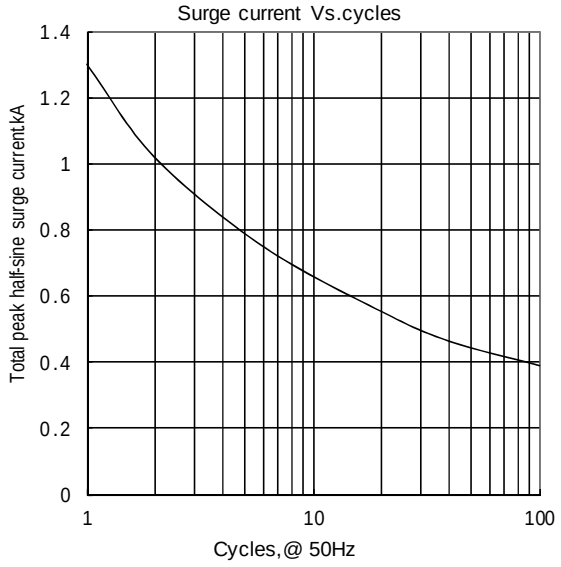


Fig.7

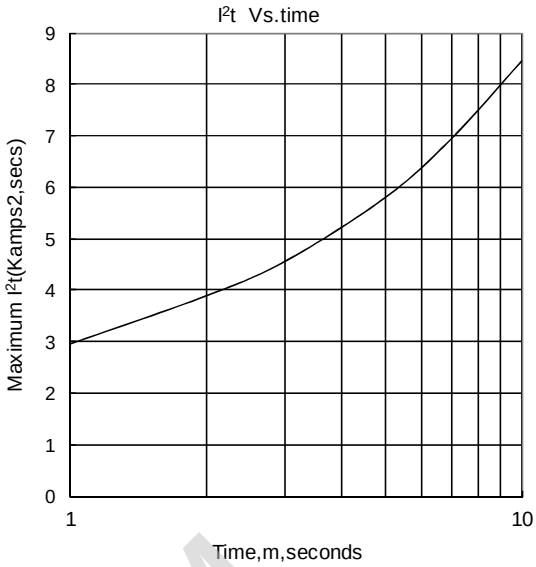
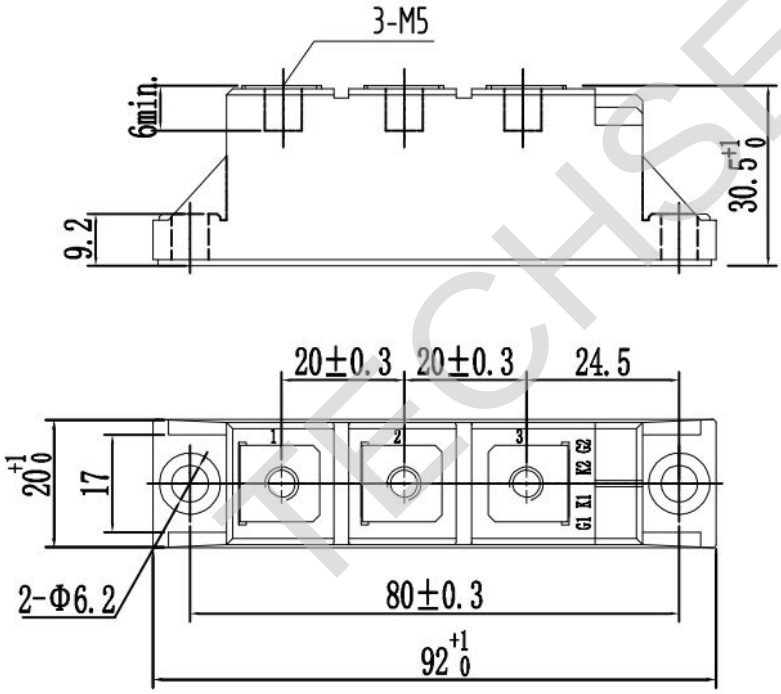
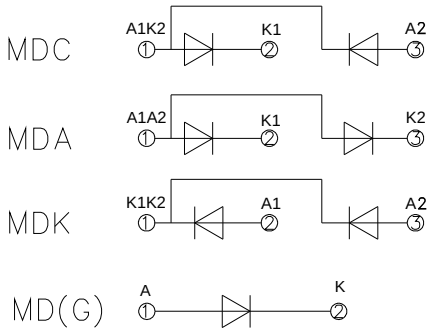


Fig.8

Outline:





Unmarked dimensional tolerance：±0.5mm